



# MOSFET

# OptiMOS<sup>™</sup> Power-Transistor, -100 V

### **Features**

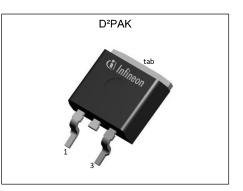
- P-channel
- 100% avalanche tested
- Normal level
- Enhancement mode
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

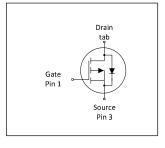
## **Product validation**

Fully qualified according to JEDEC for Industrial Applications

#### **Key Performance Parameters** Table 1

Parameter	Value	Unit
V <sub>DS</sub>	-100	V
R <sub>DS(on),max</sub>	185	mΩ
ID	-13.8	A
Q <sub>oss</sub>	-13	nC
Q <sub>G</sub>	-36	nC









Type / Ordering Code	Package	Marking	Related Links
IPB19DP10NM	PG-TO263-3	19DP10NM	-



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# **1 Maximum ratings** at *T*<sub>A</sub>=25 °C, unless otherwise specified

### Table 2Maximum ratings

Demonstern	Cumple al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>			-13.8 -9.8 -2.9	A	$V_{GS}$ =-10 V, $T_{C}$ =25 °C $V_{GS}$ =-10 V, $T_{C}$ =100 °C $V_{GS}$ =-10 V, $T_{A}$ =25°C, $R_{thJA}$ =40°C/W <sup>2</sup> )	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	-55	А	<i>T</i> <sub>A</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	300	mJ	I <sub>D</sub> =-12 A, R <sub>GS</sub> =25 Ω	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	83 3.8	w	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2</sup> )	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

#### 2 **Thermal characteristics**

#### Table 3 **Thermal characteristics**

Devenuetor	Symbol	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	$R_{ m thJC}$	-	-	1.8	°C/W	-	
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area	R <sub>thJA</sub>	-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint <sup>2)</sup>	R <sub>thJA</sub>	-	-	62	°C/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. <sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information



# **3** Electrical characteristics at *T*<sub>j</sub>=25 °C, unless otherwise specified

#### Table 4 **Static characteristics**

Devementer	Symbol		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	-100	-	-	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>D</sub> =-1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	-2.1	-3	-4	V	V <sub>DS</sub> =V <sub>GS</sub> , <i>I</i> <sub>D</sub> =-1040 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	-0.1 -10	-1 -100	μA	V <sub>DS</sub> =-100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =-100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	-10	-100	nA	V <sub>GS</sub> =-20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	148.6	185	mΩ	V <sub>GS</sub> =-10 V, <i>I</i> <sub>D</sub> =-12 A	
Gate resistance	R <sub>G</sub>	-	5.1	-	Ω	-	
Transconductance	$g_{ m fs}$	-	15	-	S	<i>V</i> <sub>DS</sub>  ≥2  <i>I</i> <sub>D</sub>   <i>R</i> <sub>DS(on)max</sub> , <i>I</i> <sub>D</sub> =-12 A	

#### Table 5 **Dynamic characteristics**

Devenenter	Cumb al		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	1500	2000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =-50 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	110	140	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =-50 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	23	40	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =-50 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	9.11	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-12 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	tr	-	17.84	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-12 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{\rm d(off)}$	-	44.53	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-12 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	22.8	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-12 A, $R_{\rm G,ext}$ =1.6 $\Omega$

#### Gate charge characteristics<sup>2)</sup> Table 6

Parameter	Come had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	-7.8	-	nC	V <sub>DD</sub> =-50 V, <i>I</i> <sub>D</sub> =-12 A, <i>V</i> <sub>GS</sub> =0 to -10 V
Gate charge at threshold	$Q_{g(th)}$	-	-4.6	-	nC	$V_{DD}$ =-50 V, $I_{D}$ =-12 A, $V_{GS}$ =0 to -10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	-11.9	-17.9	nC	V <sub>DD</sub> =-50 V, <i>I</i> <sub>D</sub> =-12 A, <i>V</i> <sub>GS</sub> =0 to -10 V
Switching charge	Q <sub>sw</sub>	-	-15	-	nC	V <sub>DD</sub> =-50 V, <i>I</i> <sub>D</sub> =-12 A, <i>V</i> <sub>GS</sub> =0 to -10 V
Gate charge total <sup>1)</sup>	Qg	-	-36	-45	nC	V <sub>DD</sub> =-50 V, <i>I</i> <sub>D</sub> =-12 A, <i>V</i> <sub>GS</sub> =0 to -10 V
Gate plateau voltage	V <sub>plateau</sub>	-	-5	-	V	V <sub>DD</sub> =-50 V, <i>I</i> <sub>D</sub> =-12 A, <i>V</i> <sub>GS</sub> =0 to -10 V
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	-13	-17	nC	V <sub>DS</sub> =-50 V, V <sub>GS</sub> =0 V

 <sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.
 <sup>2)</sup> See "Gate charge waveforms" for parameter definition

# OptiMOS<sup>™</sup> Power-Transistor, -100 V IPB19DP10NM



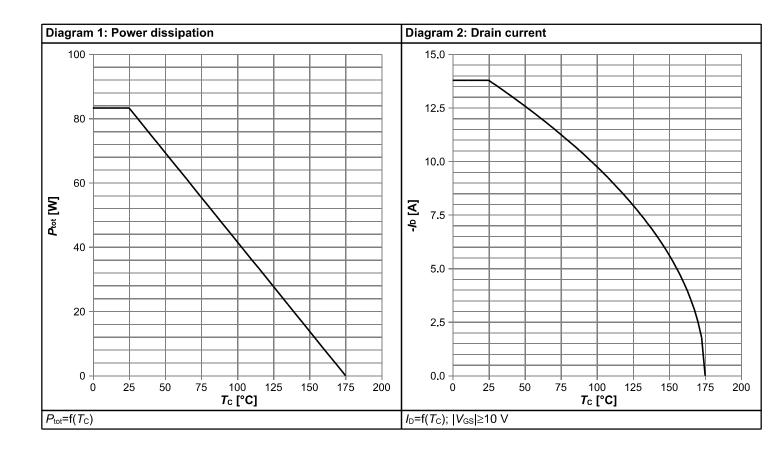
## Table 7Reverse diode

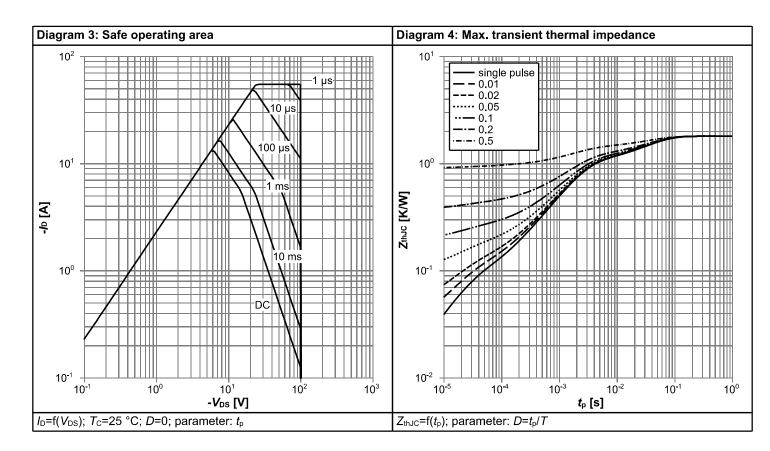
Devemeter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	ls	-	-	-13.8	А	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	-55	А	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	-0.87	-1.2	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>F</sub> =-12 A, <i>T</i> <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	73.05	146.1	ns	<i>V</i> <sub>R</sub> =-50 V, <i>I</i> <sub>F</sub> =-12 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =-100 A/μs	
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>	-	257.37	514.74	nC	V <sub>R</sub> =-50 V, <i>I</i> <sub>F</sub> =-12 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =-100 A/μs	

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.

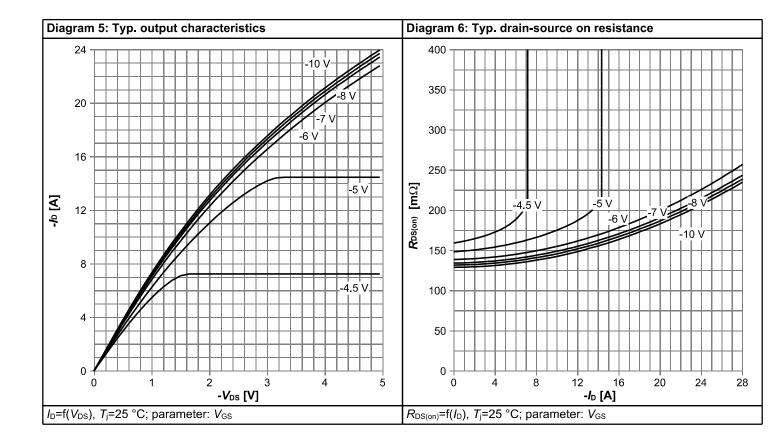


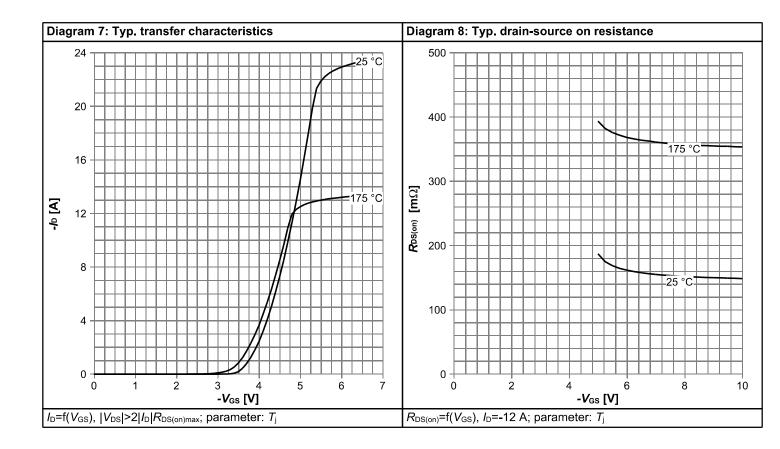
# 4 Electrical characteristics diagrams



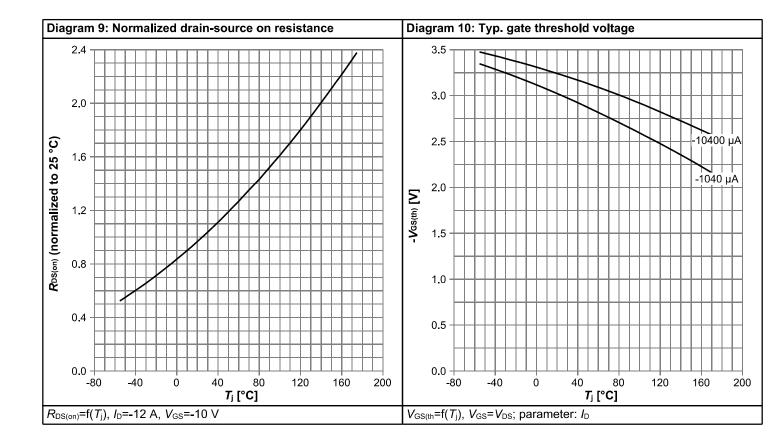


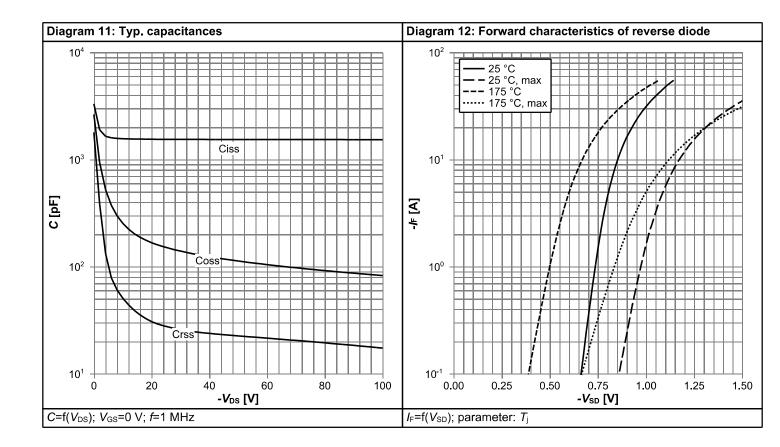




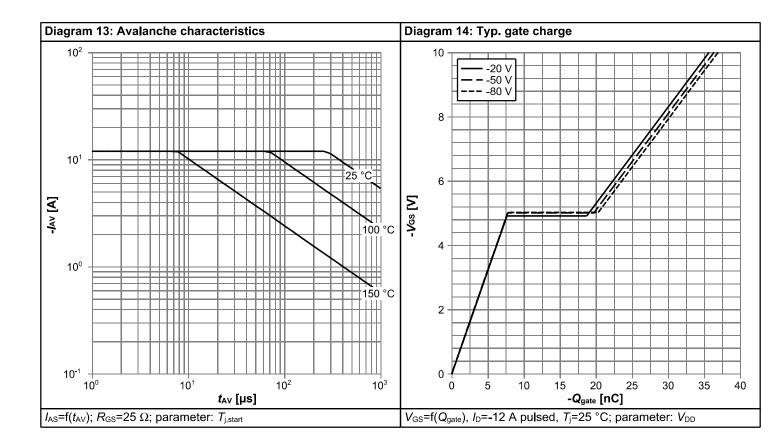


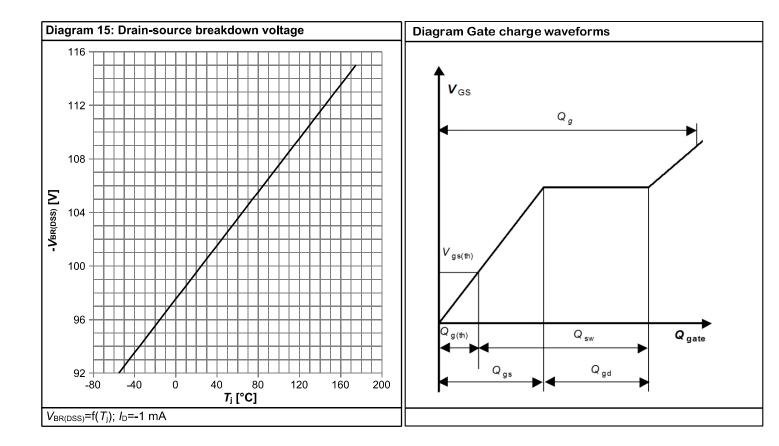






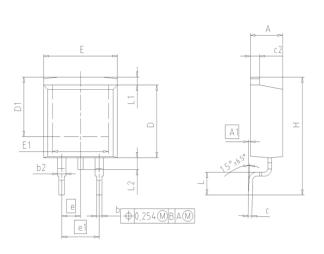


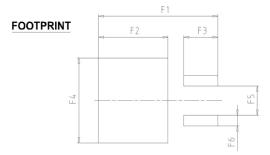






# 5 Package Outlines





DIM	MILLIN	IETERS	INC	HES	
DIW	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.25	0.000	0.010	
b	0.65	0.85	0.026	0.033	DOCUMENT NO.
b2	0.95	1.15	0.037	0.045	Z8B00003324
с	0.33	0.65	0.013	0.026	0
c2	1.17	1.40	0.046	0.055	SCALE 0
D	8.51	9.45	0.335	0.372	
D1	7.10	7.90	0.280	0.311	
E	9.80	10.31	0.386	0.406	0 5
E1	6.50	8.60	0.256	0.339	0 5 5
e	2.	54	0.	100	7.5mm
e1	5.	08	0.	200	mmc.v
N		2		2	EUROPEAN PROJECTION
н	14.61	15.88	0.575	0.625	Lokol EART Robertion
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9.30	9.50	0.366	0.374	ISSUE DATE
F3	4.50	4.70	0.177	0.185	30-08-2007
F4	10.70	10.90	0.421	0.429	
F5	3.65	3.85	0.144	0.152	REVISION
F6	1.25	1.45	0.049	0.057	01

# Figure 1 Outline PG-TO263-3, dimensions in mm/inches



## **Revision History**

IPB19DP10NM

### Revision: 2021-05-10, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-05-10	Release of final version				

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